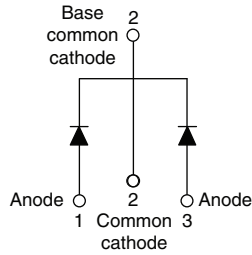


Schottky Rectifier, 2 x 10 A



TO-220AB



FEATURES

- 150 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Designed and qualified according to JEDEC®-JESD47
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



PRODUCT SUMMARY

Package	TO-220AB
$I_{F(AV)}$	2 x 10 A
V_R	80 V, 90 V, 100 V
V_F at I_F	0.70 V
I_{RM} max.	6 mA at 125 °C
T_J max.	150 °C
Diode variation	Common cathode
E_{AS}	24 mJ

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform (per device)	20	A
I_{FRM}	$T_C = 133$ °C per leg	20	A
V_{RRM}		80/100	V
I_{FSM}	$t_p = 5$ μ s sine	850	A
V_F	10 A_{pk} , $T_J = 125$ °C	0.70	V
T_J	Range	- 65 to + 150	°C

VOLTAGE RATINGS

PARAMETER	SYMBOL	MBR2080CT PbF	MBR2080CT -N3	MBR2090CT PbF	MBR2090CT -N3	MBR20100CT PbF	MBR20100CT -N3	UNITS
Maximum DC reverse voltage	V_R	80		90		100		V
Maximum working peak reverse voltage	V_{RWM}	80		90		100		V



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 133\text{ }^\circ\text{C}$, rated V_R	per leg	10	A
			per device	20	
Peak repetitive forward current per leg	I_{FRM}	Rated V_R , square wave, 20 kHz, $T_C = 133\text{ }^\circ\text{C}$		20	
Non-repetitive peak surge current	I_{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V_{RRM} applied	850	
		Surge applied at rated load conditions halfwave, single phase, 60 Hz		150	
Peak repetitive reverse surge current	I_{RRM}	2.0 μs , 1.0 kHz		0.5	
Non-repetitive avalanche energy per leg	E_{AS}	$T_J = 25\text{ }^\circ\text{C}$, $I_{AS} = 2\text{ A}$, $L = 12\text{ mH}$		24	mJ

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}^{(1)}$	10 A	$T_J = 25\text{ }^\circ\text{C}$	0.80	V
		20 A		0.95	
		10 A	$T_J = 125\text{ }^\circ\text{C}$	0.70	
		20 A		0.85	
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	Rated DC voltage	0.10	mA
		$T_J = 125\text{ }^\circ\text{C}$		6	
Threshold voltage	$V_{F(TO)}$	$T_J = T_J$ maximum		0.433	V
Forward slope resistance	r_t			15.8	m Ω
Maximum junction capacitance	C_T	$V_R = 5\text{ V}_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^\circ\text{C}$		400	pF
Typical series inductance	L_S	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V_R		10 000	V/ μs

Note

⁽¹⁾ Pulse width < 300 μs , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction temperature range	T_J			- 65 to 150	$^\circ\text{C}$
Maximum storage temperature range	T_{Stg}			- 65 to 175	
Maximum thermal resistance, junction to case per leg	R_{thJC}	DC operation		2.0	$^\circ\text{C}/\text{W}$
Typical thermal resistance, case to heatsink	R_{thCS}	Mounting surface, smooth and greased (Only for TO-220)		0.50	
Maximum thermal resistance, junction to ambient	R_{thJA}	DC operation (For D ² PAK and TO-262)		50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum			6 (5)	kg · cm (lbf · in)
	maximum			12 (10)	
Marking device				MBR2080CT MBR2090CT MBR20100CT	

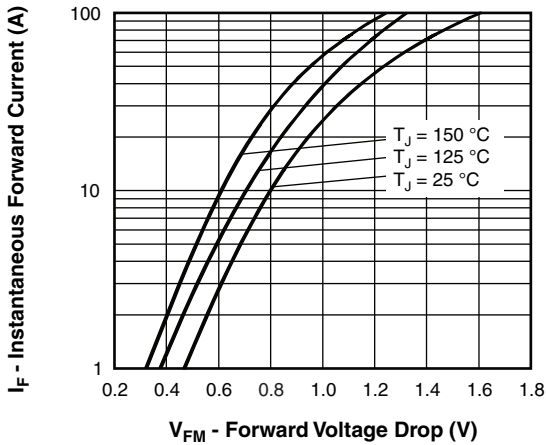


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

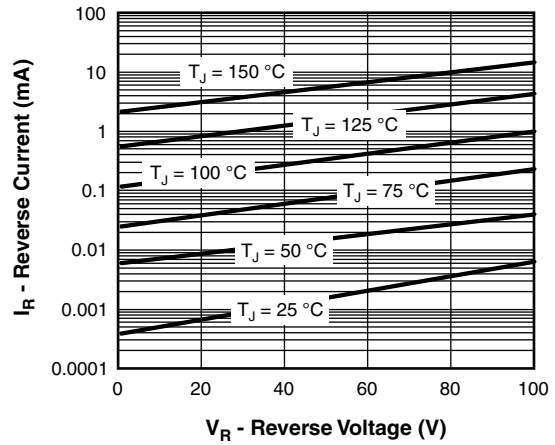


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

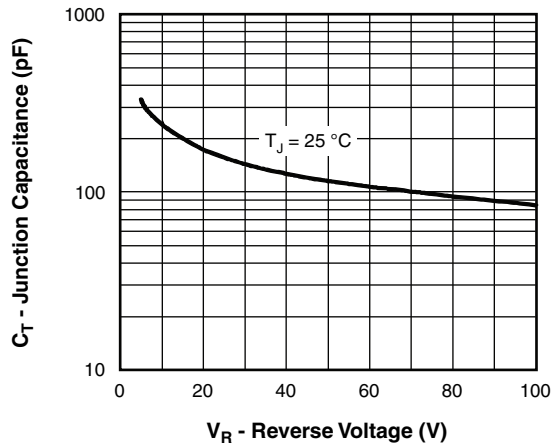


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

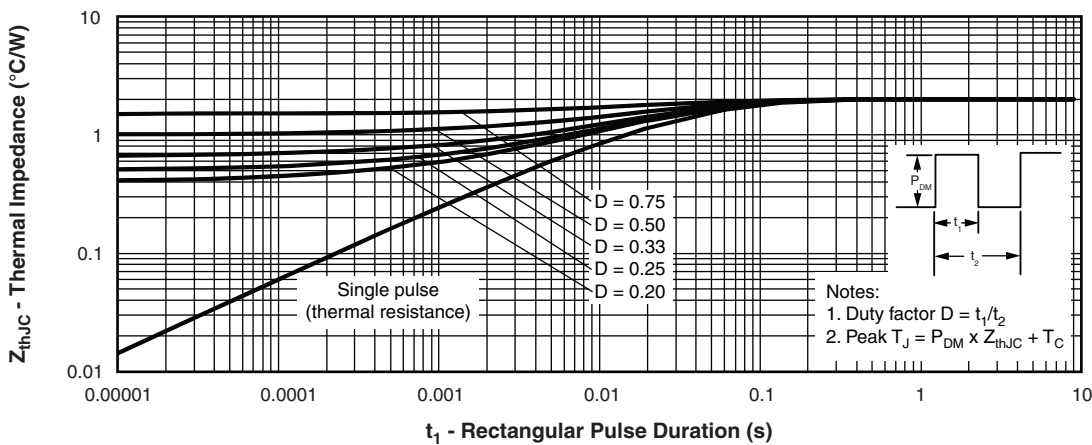


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

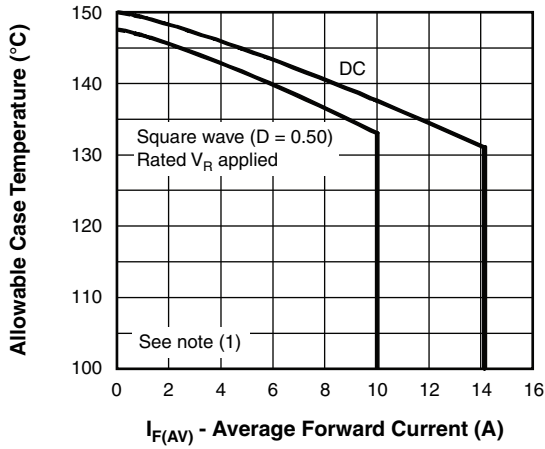


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

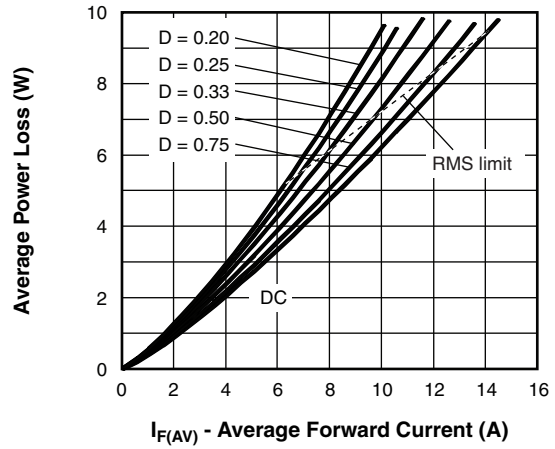


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

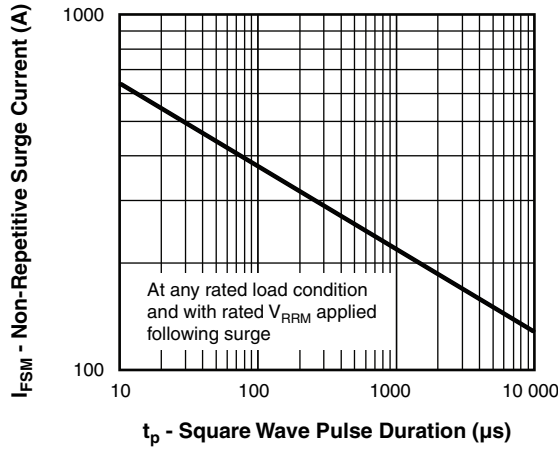


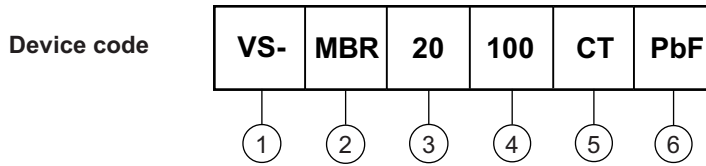
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$;
 P_d = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 $P_{d_{REV}}$ = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = Rated V_R



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Schottky MBR series
- 3** - Current rating (20 = 20 A)
- 4** - Voltage ratings

080 = 80 V
090 = 90 V
100 = 100 V
- 5** - CT = Essential part number
- 6** -
 - PbF = Lead (Pb)-free
 - -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-MBR2080CTPbF	50	1000	Antistatic plastic tube
VS-MBR2080CT-N3	50	1000	Antistatic plastic tube
VS-MBR2090CTPbF	50	1000	Antistatic plastic tube
VS-MBR2090CT-N3	50	1000	Antistatic plastic tube
VS-MBR20100CTPbF	50	1000	Antistatic plastic tube
VS-MBR20100CT-N3	50	1000	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95222
Part marking information	TO-220AB PbF www.vishay.com/doc?95225
	TO-220AB -N3 www.vishay.com/doc?95028

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

- 1. - Anode/open
- 2. - Cathode
- 3. - Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
e	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
Ø P	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° to 93°		90° to 93°		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



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